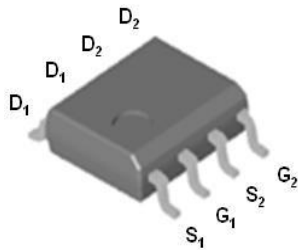


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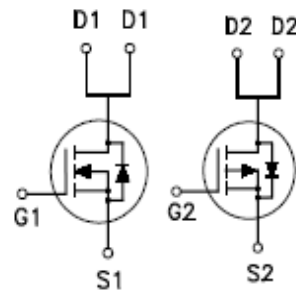
N&P-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D	Channel
30V	20m Ω @ $V_{GS} = 10V$	8.8A	N
-30V	25m Ω @ $V_{GS} = -10V$	-8A	P



SOP-8



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	CH.	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	N	30	V
			P	-30	
Gate-Source Voltage		V_{GS}	N	± 20	
			P	± 20	
Continuous Drain Current	$T_A = 25\text{ }^\circ\text{C}$	I_D	N	8.8	A
			P	-8	
	$T_A = 70\text{ }^\circ\text{C}$		N	7	
			P	-6.4	
Pulsed Drain Current ¹		I_{DM}	N	35	
			P	-32	
Avalanche Current		I_{AS}	N	27	
			P	-28	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	N	38	mJ
			P	39	
Power Dissipation	$T_A = 25\text{ }^\circ\text{C}$	P_D	N	2.5	W
			P		
	$T_A = 70\text{ }^\circ\text{C}$		N	1.6	
			P		
Junction & Storage Temperature Range		T_j, T_{stg}		-55 to 150	$^\circ\text{C}$

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N&P-Channel Enhancement Mode MOSFET

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		50	°C / W

¹Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	CH.	LIMITS			UNITS
				MIN	TYP	MAX	
STATIC							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	N	30			V
		$V_{GS} = 0V, I_D = -250\mu A$	P	-30			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	N	1.7	2.3	3	
		$V_{DS} = V_{GS}, I_D = -250\mu A$	P	-1.7	-2.3	-3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	N			± 100	nA
		$V_{DS} = 0V, V_{GS} = \pm 20V$	P			± 100	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$	N			1	μA
		$V_{DS} = -24V, V_{GS} = 0V$	P			-1	
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 55\text{ }^\circ\text{C}$	N			10	
		$V_{DS} = -20V, V_{GS} = 0V, T_J = 55\text{ }^\circ\text{C}$	P			-10	
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = 5V, V_{GS} = 10V$	N	35			A
		$V_{DS} = -5V, V_{GS} = -10V$	P	-32			
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 6A$	N		19	40	m Ω
		$V_{GS} = -4.5V, I_D = -7A$	P		34	70	
		$V_{GS} = 10V, I_D = 8A$	N		13	20	
		$V_{GS} = -10V, I_D = -8A$	P		17	25	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 10V, I_D = 8A$	N		28		S
		$V_{DS} = -10V, I_D = -8A$	P		20		

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N&P-Channel Enhancement Mode MOSFET

DYNAMIC						
Input Capacitance	C_{iss}	N-Channel $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$	N	888		pF
			P	1520		
Output Capacitance	C_{oss}	P-Channel $V_{GS} = 0V, V_{DS} = -15V, f = 1MHz$	N	217		pF
			P	322		
Reverse Transfer Capacitance	C_{rss}	N-Channel $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$	N	114		pF
			P	194		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$	N	1.8		Ω
			P	3.4		
Total Gate Charge ²	Q_g	N-Channel $V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = 10V, I_D = 8A$	N	17		nC
			P	26		
Gate-Source Charge ²	Q_{gs}	P-Channel $V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = -10V, I_D = -8A$	N	3.2		nC
			P	6		
Gate-Drain Charge ²	Q_{gd}	N-Channel $V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = -10V, I_D = -8A$	N	5		nC
			P	6.7		
Turn-On Delay Time ²	$t_{d(on)}$	N-Channel $V_{DS} = 15V, I_D \cong 1A, V_{GS} = 10V, R_{GEN} = 6\Omega$	N	6.7		nS
			P	14.2		
Rise Time ²	t_r	P-Channel $V_{DS} = -15V, I_D \cong -1A, V_{GS} = -10V, R_{GEN} = 6\Omega$	N	5.9		nS
			P	12		
Turn-Off Delay Time ²	$t_{d(off)}$	N-Channel $V_{DS} = 15V, I_D \cong 1A, V_{GS} = 10V, R_{GEN} = 6\Omega$	N	22.4		nS
			P	66		
Fall Time ²	t_f	P-Channel $V_{DS} = -15V, I_D \cong -1A, V_{GS} = -10V, R_{GEN} = 6\Omega$	N	4.3		nS
			P	33		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S		N	2.5		A
			P	-2.5		
Forward Voltage ¹	V_{SD}	$I_F = 8A, V_{GS} = 0V$	N	1		V
		$I_F = -8A, V_{GS} = 0V$	P	-1		
Reverse Recovery Time	t_{rr}	$I_F = 8A, di_F/dt = 100A / \mu S$	N	17.4		nS
		$I_F = -8A, di_F/dt = 100A / \mu S$	P	17.5		
Reverse Recovery Charge	Q_{rr}	$I_F = 8A, di_F/dt = 100A / \mu S$	N	7		nC
		$I_F = -8A, di_F/dt = 100A / \mu S$	P	8		

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

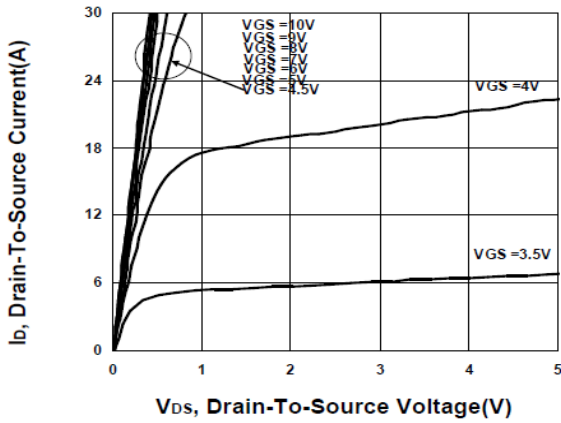
²Independent of operating temperature.

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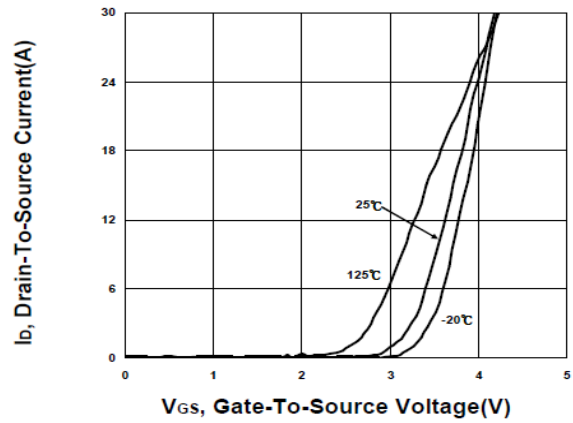
N&P-Channel Enhancement Mode MOSFET

TYPICAL PERFORMANCE CHARACTERISTICS N-CHANNEL

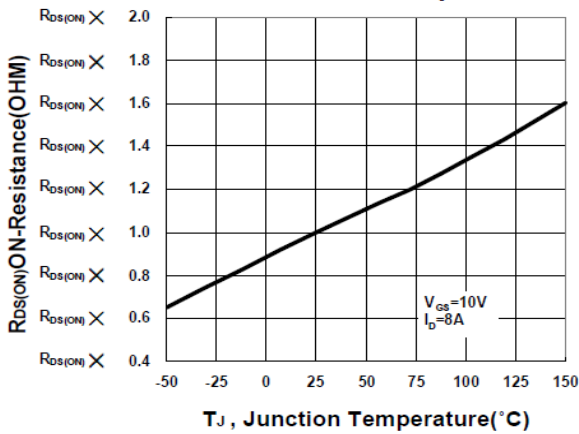
Output Characteristics



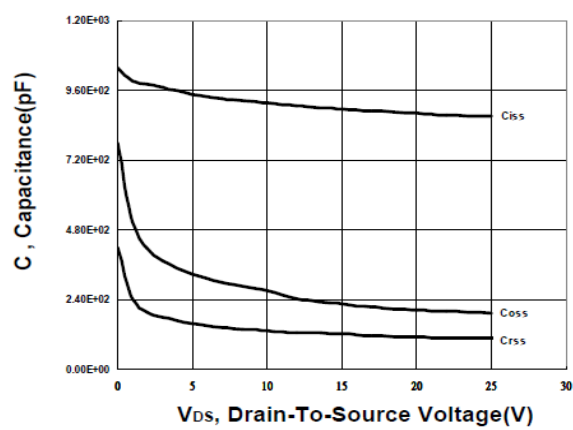
Transfer Characteristics



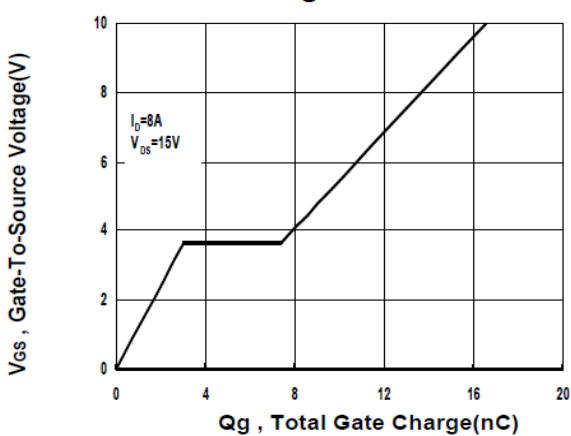
On-Resistance VS Temperature



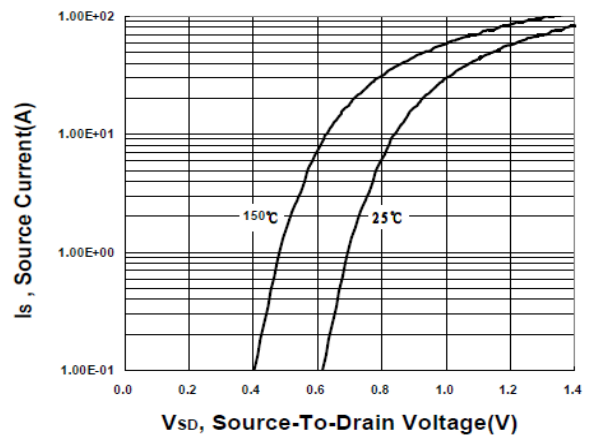
Capacitance Characteristic



Gate charge Characteristics



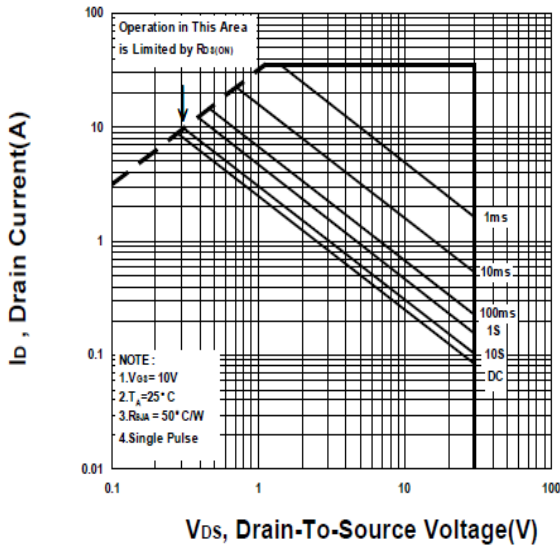
Source-Drain Diode Forward Voltage



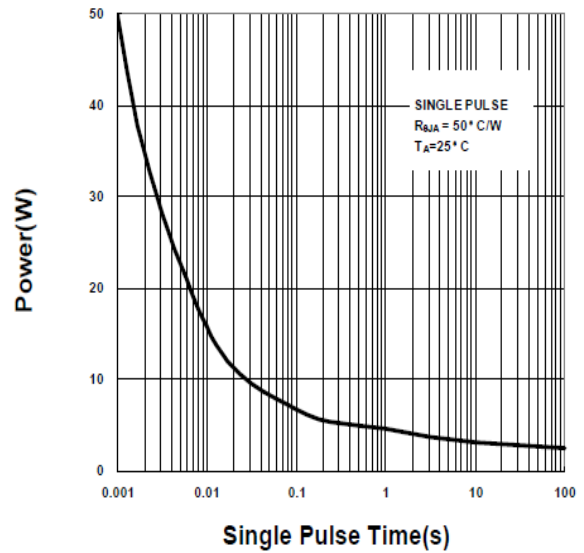
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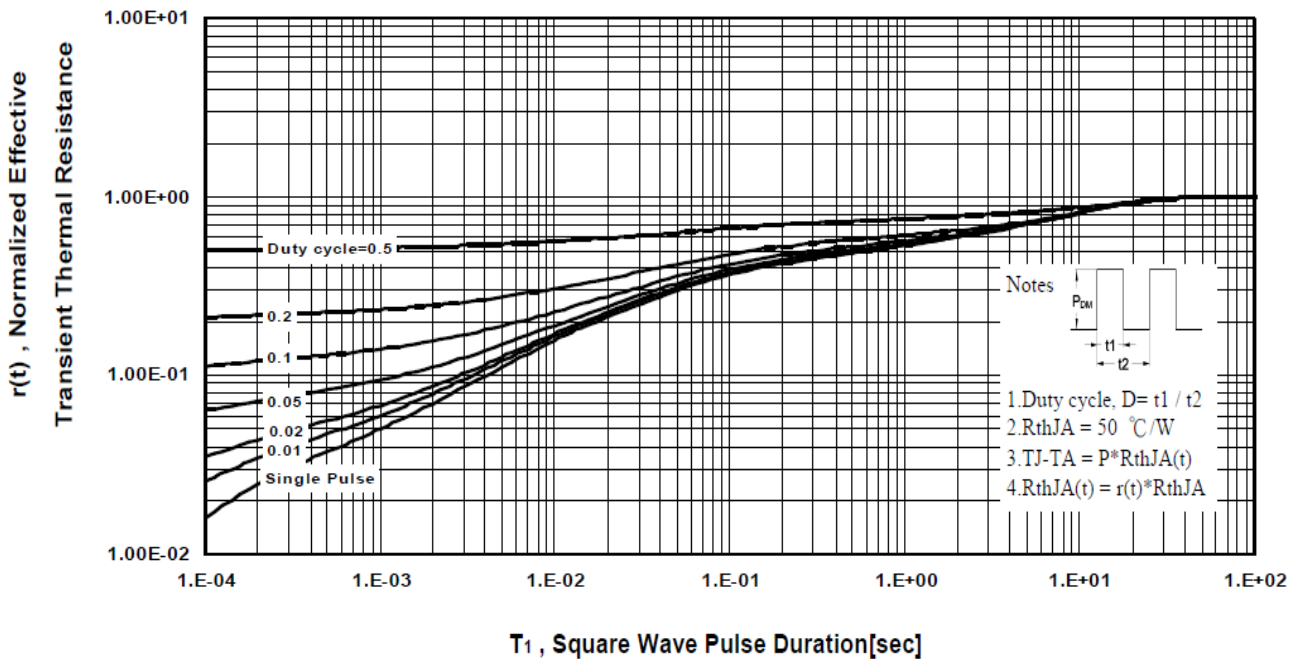
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

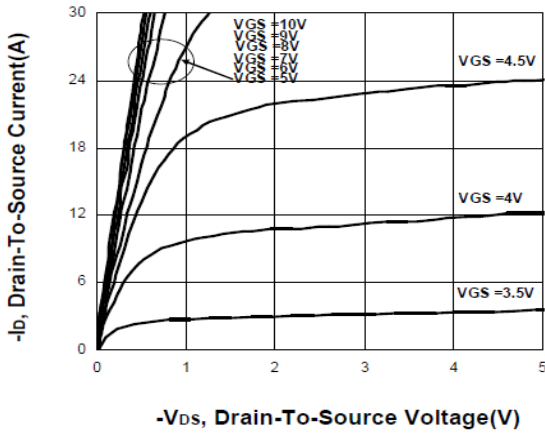


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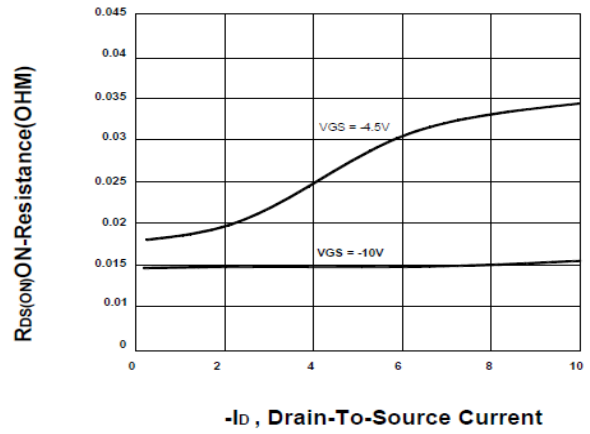
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P-CHANNEL

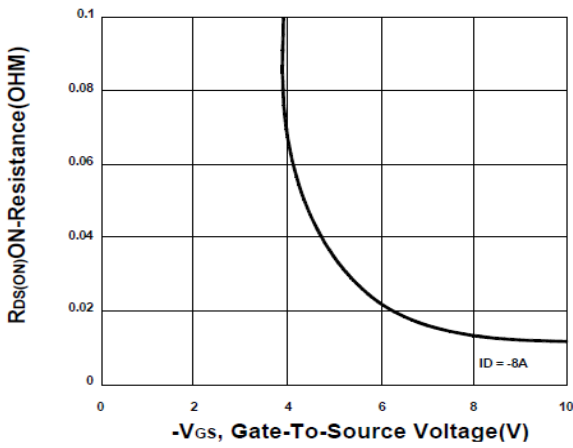
Output Characteristics



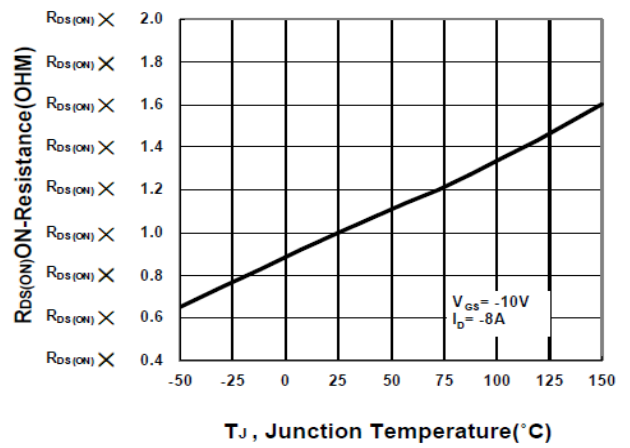
On-Resistance VS Drain Current



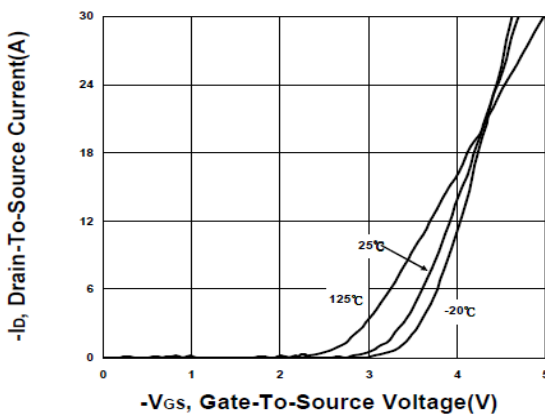
On-Resistance VS Gate-To-Source



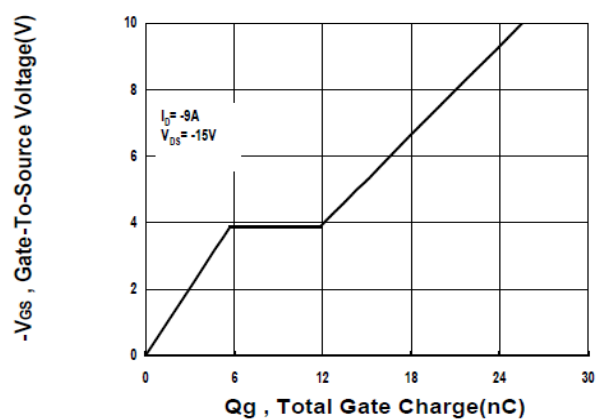
On-Resistance VS Temperature



Transfer Characteristics



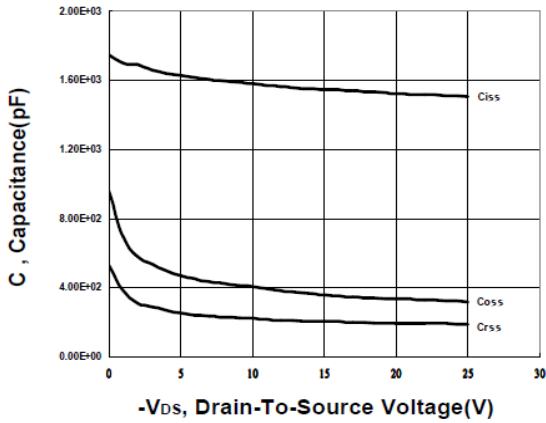
Gate charge Characteristics



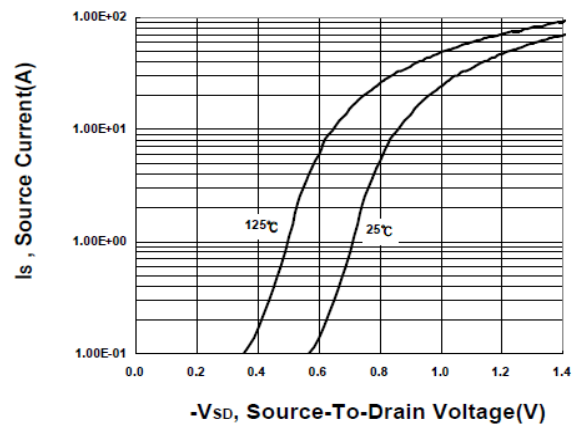
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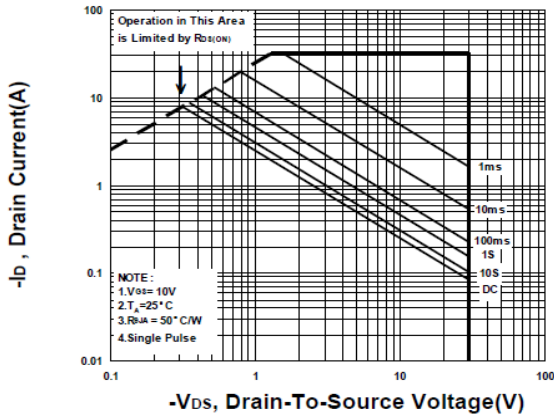
Capacitance Characteristic



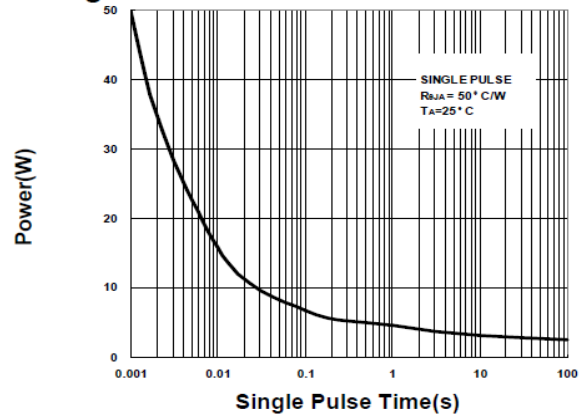
Source-Drain Diode Forward Voltage



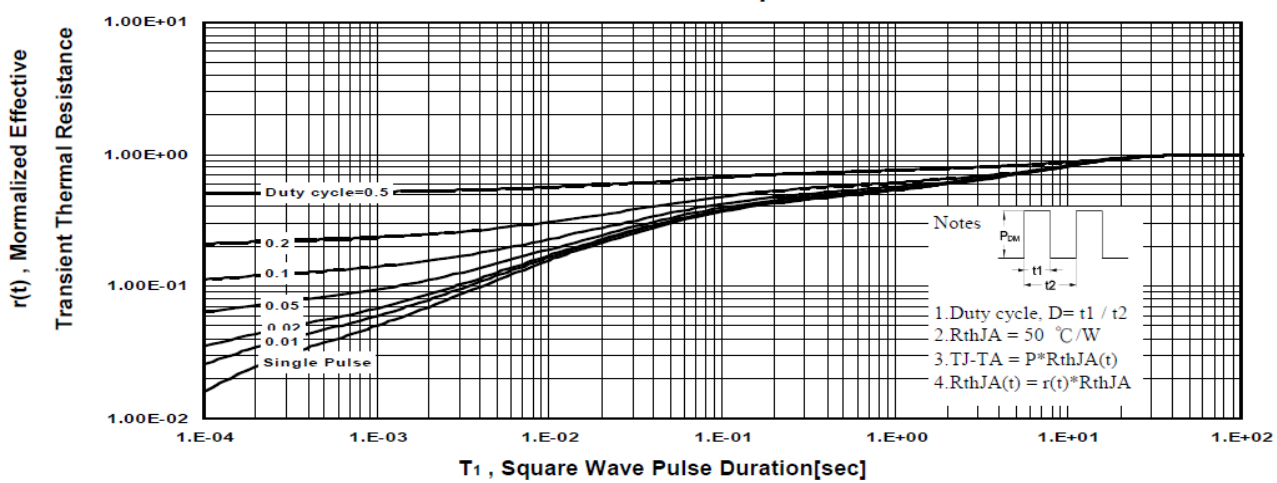
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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N&P-Channel Enhancement Mode MOSFET

Package Dimension

SOP-8 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.4	0.6	0.93
B	3.8	3.9	4.0	I	0.19	0.21	0.25
C	5.79	6.0	6.2	J	0.25	0.375	0.5
D	0.33	0.4	0.51	K	0°	3°	18°
E	1.25	1.27	1.29				
F	1.1	1.3	1.65				
G	0.05	0.15	0.25				

